

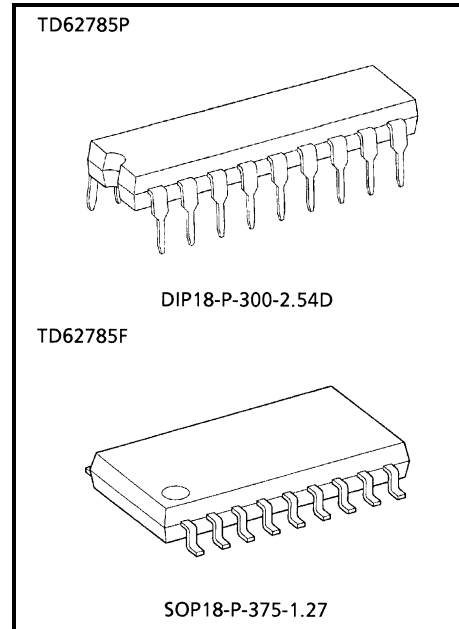
TD62785P, TD62785F

8CH SOURCE DRIVER

The TD62785P, TD62785F are eight Channel Non-Inverting Source current transistor Array. All units feature input pull-up resistors and output pull-down resistors. These device are specifically designed for multiplexed digit driving of eight digit common-anode LED and also can be employed as a source drivers for multiplexed LED displays using with the TD62381P, TD62381F at standard supply voltage, 5 V. Applications include relay, hammer and lamp drivers.

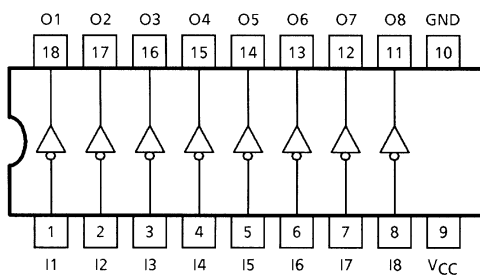
FEATURES

- Low saturation voltage $V_{CE(sat)} = 1.35\text{ V (max)}$
@ $I_{OUT} = -500\text{ mA}$
- Output current (single output) $I_{OUT} = -500\text{ mA (min)}$
- Input pull-up resistor $R_{IN} = 5.6\text{ k}\Omega\text{ (typ.)}$.
- Output pull-down resistor $R_{IN} = 15\text{ k}\Omega\text{ (typ.)}$
- Low level active inputs
- Package Type-P: DIP-18 pin
- Package Type-F: SOP-18 pin

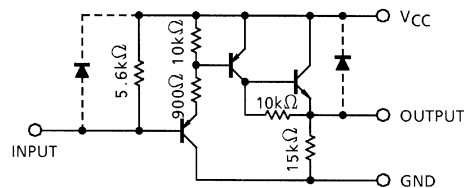


Weight
 DIP18-P-300-2.54D: 1.47 g (typ.)
 SOP18-P-375-1.27: 0.41 g (typ.)

PIN CONNECTION (TOP VIEW)



SCHEMATICS (EACH DRIVER)



Note: The input and output parasitic diodes cannot be used as clamp diodes.

ABSOLUTE MAXIMUM RATING (Ta = 25°C)

CHARACTERISTIC	SYMBOL	RATING	UNIT
Supply Voltage	V _{CC}	7.0	V
Output Voltage	V _{OUT}	V _{CC}	V
Output Current	I _{OUT}	-500	mA / ch
Input Voltage	V _{IN}	V _{CC}	V
Input Current	I _{IN}	-10	mA
Power Dissipation	P	P _D (Note 1)	W
	F		
Operating Temperature	T _{opr}	-40~85	°C
Storage Temperature	T _{stg}	-55~150	°C

Note 1: Delated above 25°C in the proportion of 11.7 mW / °C (P-Type), 7.7 mW / °C (F-Type).

RECOMMENDED OPERATING CONDITIONS (Ta = -40~85°C)

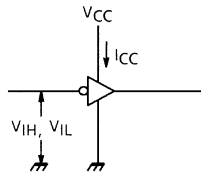
CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT	
Supply Voltage	V _{CC}	—	4.5	5.0	5.5	V	
Output Voltage	V _{OUT}	—	0	—	-V _{CC}	V	
Output Current	P	I _{OUT}	DC 1 Circuit, Ta = 25°C	0	—	-400	mA / ch
				0	—	-400	
	F	T _{pw} ≤ 25 ms 8 Circuits On T _a = 85°C T _j = 120°C	Duty = 10%	0	—	-376	
			Duty = 50%	0	—	-67	
			Duty = 10%	0	—	-248	
Duty = 50%	0	—	-38				
Input Voltage	V _{IN}	—	0	—	V _{CC}	V	
	Output On	V _{IN (ON)}	—	0	0.8	V	
	Output Off	V _{IN (OFF)}	—	V _{CC} -1.0	V _{CC}		
Power Dissipation	P	P _D	—	—	0.52	W	
	F	—	—	—	0.35		

ELECTRICAL CHARACTERISTICS (Ta = 25°C)

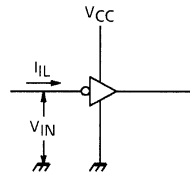
CHARACTERISTIC		SYMBOL	TEST CIR-CUIT	TEST CONDITION	MIN	TYP.	MAX	UNIT	
Input Voltage	"H" Level	V_{IH}	1	—	$V_{CC} - 1.0$	—	—	V	
	"L" Level	V_{IL}		—	—	—	0.8		
Input Current	"L" Level	I_{IL}	2	$V_{CC} = 5.5 \text{ V}, V_{IN} = 0.8 \text{ V}$	—	-1.5	-2.3	mA	
Input Pull-Up Resistor		R_{IP}	—	—	—	5.6	—	k Ω	
Output Pull-Down Resistor		R_{OP}	—	—	—	15	—	k Ω	
Output Voltage	"H" Level	V_{OH}	3	$V_{CC} = 0 \text{ V}$ $GND = -4.5 \text{ V}$ $V_{IN} = GND$	$I_{OUT} = 500 \text{ mA}$	—	—	$V_{CC} - 1.35$	V
					$I_{OUT} = 500 \text{ mA}$	—	—	$V_{CC} - 1.30$	
Supply Current		$I_{CC} \text{ (ON)}$	1	$V_{CC} = 55 \text{ V}, V_{IN} = GND$	—	—	12.5	mA / ch	
		$I_{CC} \text{ (OFF)}$			—	—	10		μA
Turn-On Delay		t_{ON}	4	$V_{CC} = 5 \text{ V}, R_L = 16 \Omega$ $C_L = 15 \text{ pF}$	—	0.1	—	μs	
Turn-Off Delay		t_{OFF}			—	3.5	—	μs	

TEST CIRCUIT

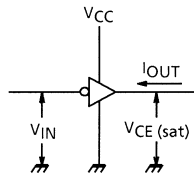
1. V_{IH} , V_{IL} , I_{CC}



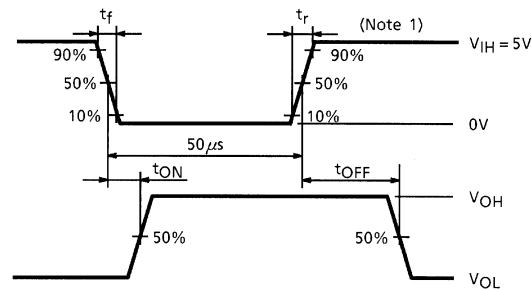
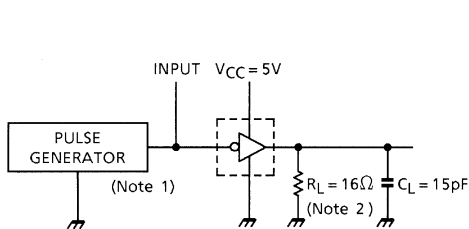
2. I_{IL}



3. $V_{CE(sat)}$



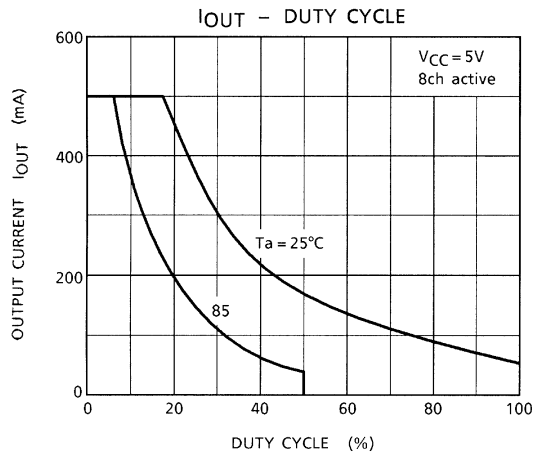
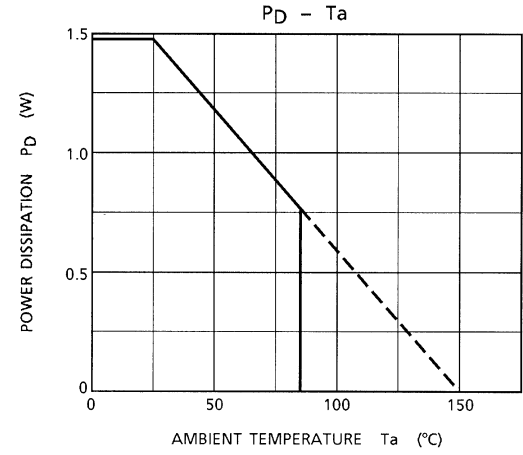
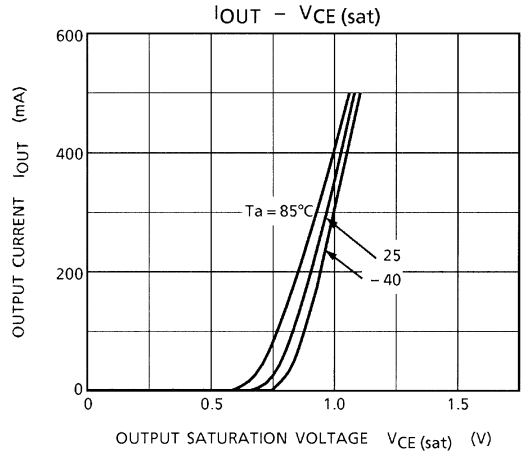
4. t_{ON} , t_{OFF}



- Note 1: Pulse width 50 μ s, duty cycle 10%
 Output impedance 50 Ω , $t_r \leq 5$ ns, $t_f \leq 10$ ns
 Note 2: C_L includes probe and jig capacitance

PRECAUTIONS for USING

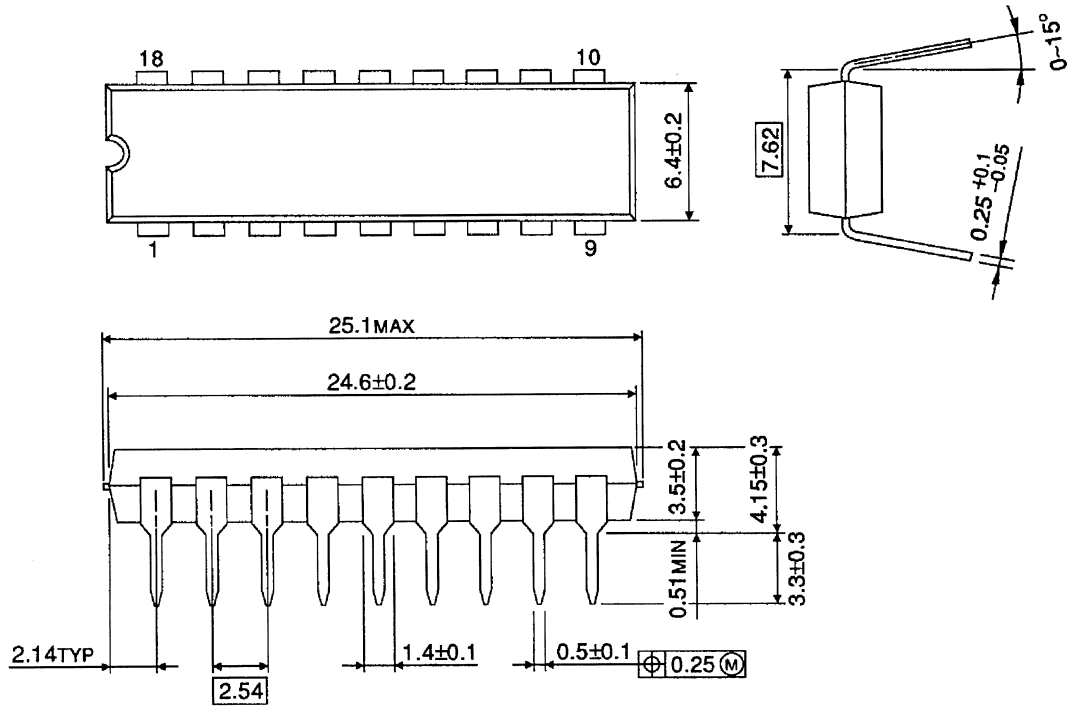
This IC does not integrate protection circuits such as overcurrent and overvoltage protectors. Thus, if excess current or voltage is applied to the IC, the IC may be damaged. Please design the IC so that excess current or voltage will not be applied to the IC. Utmost care is necessary in the design of the output line, V_{CC} and GND line since IC may be destroyed due to short-circuit between outputs, air contamination fault, or fault by improper grounding.



PACKAGE DIMENSIONS

DIP18-P-300-2.54D

Unit: mm

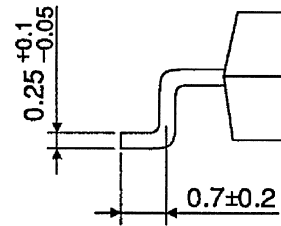
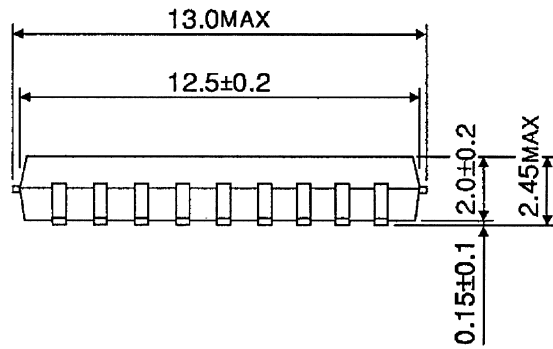
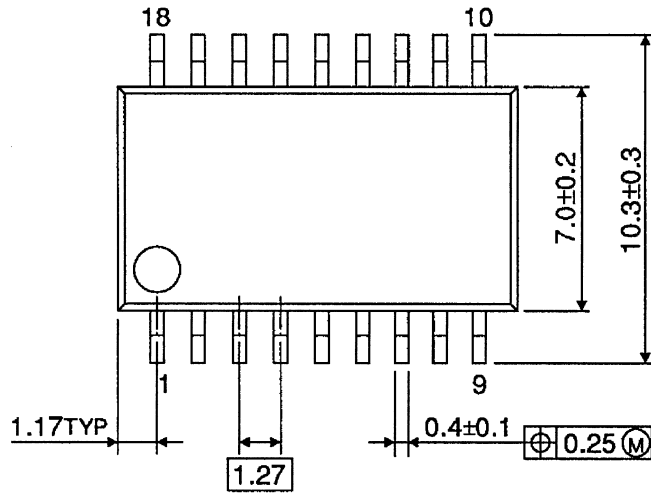


Weight: 1.47 g (typ.)

PACKAGE DIMENSIONS

SOP18-P-375-1.27

Unit: mm



Weight: 0.41 g (typ.)

Notes on Contents

1. Equivalent Circuits

The equivalent circuit diagrams may be simplified or some parts of them may be omitted for explanatory purposes.

2. Test Circuits

Components in the test circuits are used only to obtain and confirm the device characteristics. These components and circuits are not guaranteed to prevent malfunction or failure from occurring in the application equipment.

IC Usage Considerations

Notes on Handling of ICs

- (1) The absolute maximum ratings of a semiconductor device are a set of ratings that must not be exceeded, even for a moment. Do not exceed any of these ratings.
Exceeding the rating(s) may cause the device breakdown, damage or deterioration, and may result injury by explosion or combustion.
- (2) Use an appropriate power supply fuse to ensure that a large current does not continuously flow in case of over current and/or IC failure. The IC will fully break down when used under conditions that exceed its absolute maximum ratings, when the wiring is routed improperly or when an abnormal pulse noise occurs from the wiring or load, causing a large current to continuously flow and the breakdown can lead smoke or ignition. To minimize the effects of the flow of a large current in case of breakdown, appropriate settings, such as fuse capacity, fusing time and insertion circuit location, are required.
- (3) If your design includes an inductive load such as a motor coil, incorporate a protection circuit into the design to prevent device malfunction or breakdown caused by the current resulting from the inrush current at power ON or the negative current resulting from the back electromotive force at power OFF. IC breakdown may cause injury, smoke or ignition.
Use a stable power supply with ICs with built-in protection functions. If the power supply is unstable, the protection function may not operate, causing IC breakdown. IC breakdown may cause injury, smoke or ignition.
- (4) Do not insert devices in the wrong orientation or incorrectly.
Make sure that the positive and negative terminals of power supplies are connected properly. Otherwise, the current or power consumption may exceed the absolute maximum rating, and exceeding the rating(s) may cause the device breakdown, damage or deterioration, and may result injury by explosion or combustion.
In addition, do not use any device that is applied the current with inserting in the wrong orientation or incorrectly even just one time.
- (5) Carefully select external components (such as inputs and negative feedback capacitors) and load components (such as speakers), for example, power amp and regulator.
If there is a large amount of leakage current such as input or negative feedback condenser, the IC output DC voltage will increase. If this output voltage is connected to a speaker with low input withstand voltage, overcurrent or IC failure can cause smoke or ignition. (The over current can cause smoke or ignition from the IC itself.) In particular, please pay attention when using a Bridge Tied Load (BTL) connection type IC that inputs output DC voltage to a speaker directly.

Points to Remember on Handling of ICs

(1) Heat Radiation Design

In using an IC with large current flow such as power amp, regulator or driver, please design the device so that heat is appropriately radiated, not to exceed the specified junction temperature (T_j) at any time and condition. These ICs generate heat even during normal use. An inadequate IC heat radiation design can lead to decrease in IC life, deterioration of IC characteristics or IC breakdown. In addition, please design the device taking into consideration the effect of IC heat radiation with peripheral components.

(2) Back-EMF

When a motor rotates in the reverse direction, stops or slows down abruptly, a current flow back to the motor's power supply due to the effect of back-EMF. If the current sink capability of the power supply is small, the device's motor power supply and output pins might be exposed to conditions beyond maximum ratings. To avoid this problem, take the effect of back-EMF into consideration in system design.

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